



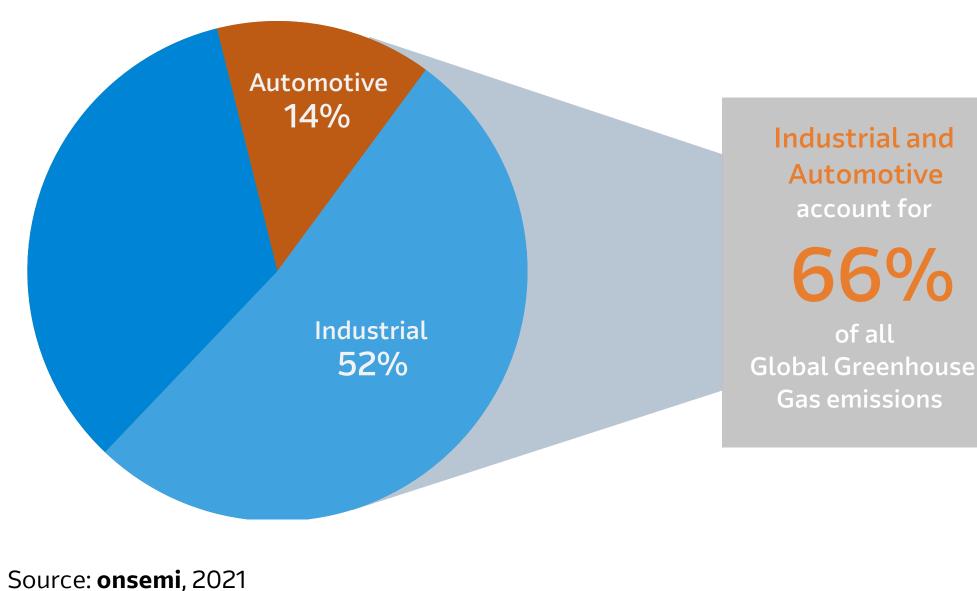
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Driving Towards Energy-Efficient Infrastructure

Energy generation, distribution, and storage are expanding markets. Increasing consumer demand and the need to meet targets set by government policy are driving stakeholder interest in new technological innovations. Superior efficiency, reduced CO₂ emissions, and a focus on renewable and clean energy are key factors in the evolution of the energy market.

High-power industrial and automotive applications consume a significant portion of the world's power and now present many opportunities for energy-efficient electronics. These applications are undergoing a transition to Silicon Carbide (SiC) power semiconductors from traditional silicon (Si) power semiconductors due to the advantages they offer — lower power consumption, higher efficiency, better reliability, and lower heat dissipation.

Global Greenhouse Gas Emissions



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onsemi addresses the needs of demanding applications such as solar inverters, electric vehicle chargers, and uninterruptible power supplies with a comprehensive portfolio of energy efficient Silicon Carbide (SiC) Diodes, MOSFETs, Modules, and Gate Drivers.

Watch video: Utilizing Wide Bandgap in Server and Industrial Power Applications





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onsemi EliteSiC Portfolio Leadership

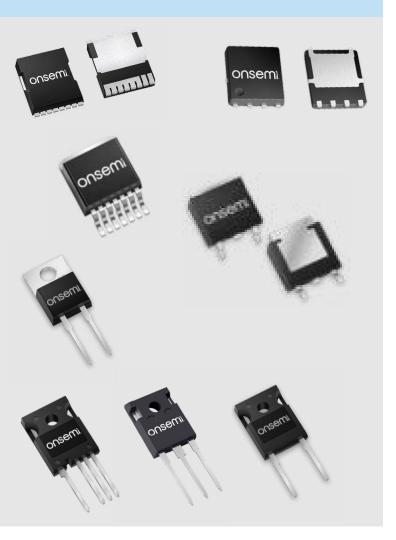
Fab Substrates/Epi SiC Planar available today Working on trench for the future 200mm migration ready – Fabs ready today for 150 mm \rightarrow - 150/200 mm SiC wafering & epi fully internal in **onsemi** today 200 mm migration - onsemi acquisition of GT Advanced Technologies complete

> **onsemi** EliteSiC technology has multiple competitive advantages, such as its internal supply chain, fully integrated manufacturing expertise, a diverse offering of devices and packages, compelling performance to price ratio, best-in-class design tools, and in-house Gate Driver solutions. The third generation of Diodes and MOSFETs are currently released with improved performances, dedicated for high frequency operation & increased performance over temperature.

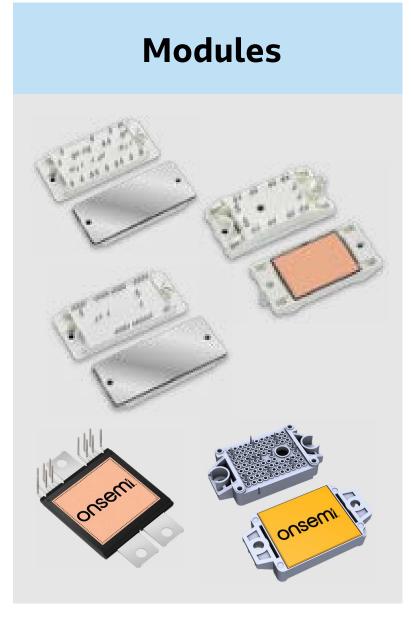
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Devices/Die



- Full portfolio of diodes & MOSFETs
- Broad base of packages
- Die only & metal options
- Auto & industrial devices



- Case & transfer molded options
- Full portfolio of hybrid & full SiC modules
- Single & dual cooling, direct & indirect

Systems







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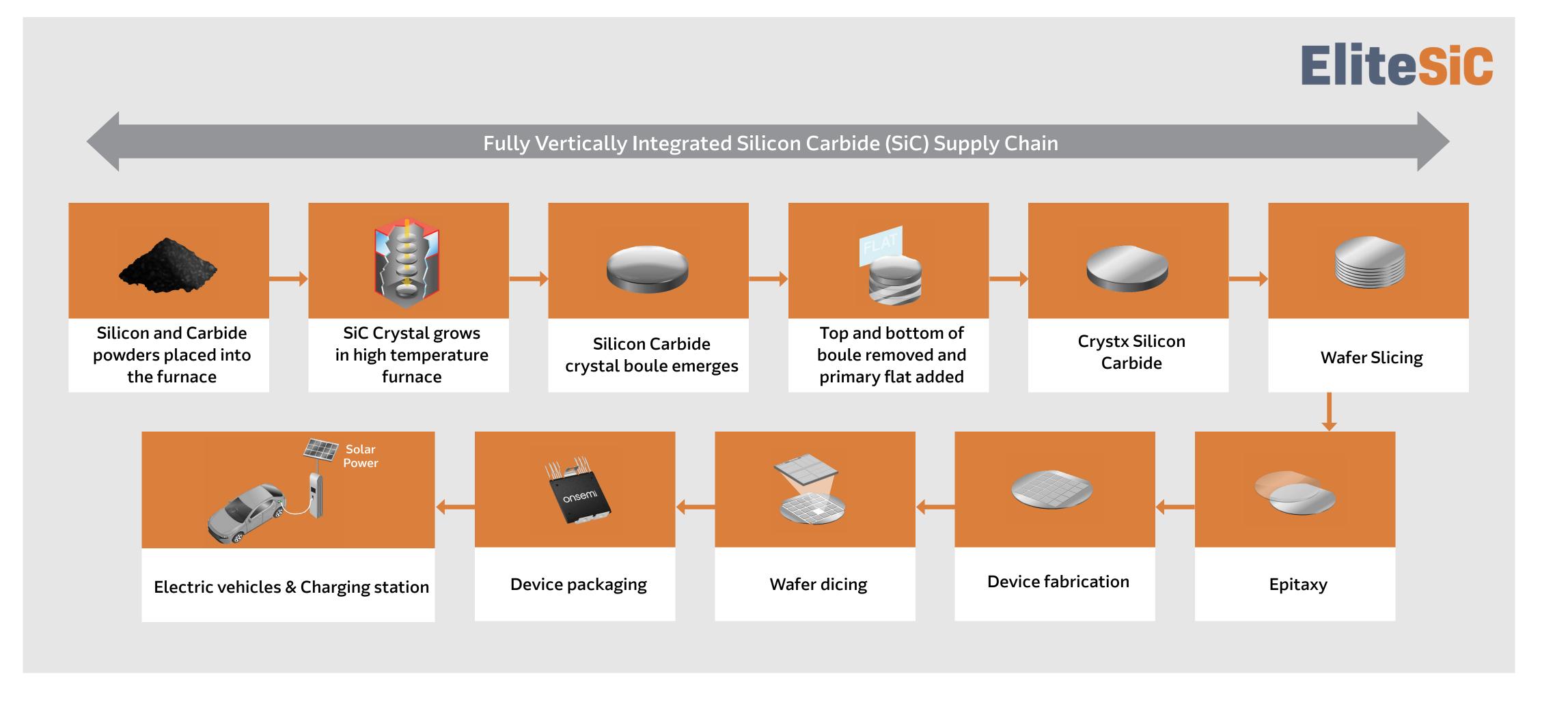




- Deep application & system know-how for automotive & industrial
- EMEA, US, Asia-based apps support

Formidable Manufacturing & Supply Chain

In-house Capability to Produce Automotive Solutions from Foundry to Final Test



SiC Solutions for Industrial Applications

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MUM

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onsemi EliteSiC Portfolio for Industrial and Energy Markets

EliteSiC Diodes

650 V/1200 V/1700 V

High efficiency, faster operating frequency, increased power density, reduced EMI, and reduced system size and cost

- No reverse QRR recovery, No forward recovery
- Low VF (lower conduction losses)
- Leakage stability over temperature range
- Switching characteristics independent of temperature
- Higher surge and avalanche capacity
- Positive temperature coefficient
- Higher operating temperature (TJMAX=175°C)
- Multiple packages available
- DPAK-3/TO-252-3LD
- D2PAK-2/TO-263-2LD
- D2PAK-3/TO-263-2LD
- PQFN-4
- TO-220-2LD
- TO-220-3LD
- TO-220FP/TO-220F-2FS
- TO-247-2LD
- TO-247–3LD

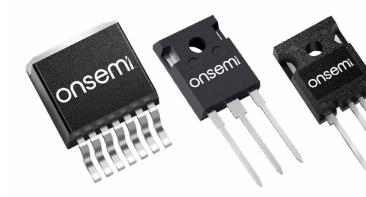


EliteSiC MOSFETs

650 V/900 V/1200 V/17

High efficiency, faster operating increased power density, reduce reduced system size and

- High power density
- Ultra-low gate charge
- Low effective output capacitant
- Low VF (lower conduction losse
- Leakage stability over tempera
- 100% UIL tested
- Higher operating temperature (TJMAX=175°C)
- Multiple packages available
- D2PAK7 (TO-263-7L HV)
- TO-247-3LD
- TO-247-4



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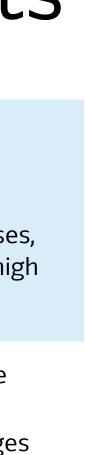
S	EliteSiC Hybrid Modules	EliteSiC Full Modules
700 V	650 V/1000 V/1200 V/1700 V	900 V/1200 V
ng frequency, Iced EMI, and Id cost	Improved efficiency with SiC diodes & fast switching low VCE (SAT) IGBT	Lower conduction and switching losses while enabling designers to achieve hig efficiency and superior reliability
nce ses) ature range	 Range of pin compatible SiC hybrid and full SiC options Integrated bypass diodes Low thermal impedance baseplate Split T-type NPC inverter I-Type NPC 1000 V, 350 A/450 A IGBT, 1200 V, 100 A SiC diode 3 Channel Symmetric Boost 1000 V, 150 A 	 Low thermal resistance from larger die than with trench MOSFETs Easy to drive with negative gate voltages Industry standard pinout with same pinot for different R_{DS(on)} levels and voltages Industry standard pinout option Reduced voltage ringing from using capacitors integrated into the module
	IGBT, 1200 V, 30 A SiC diode – 3 Channel 1200 V IGBT + SiC Boost, 80 A	(F2 module) – Q0 and Q1 Boost modules available



IGBT and 20 A SiC diode

– F1 and F2 modules available





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EliteSiC MOSFET and Diode Families

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MOSFETs

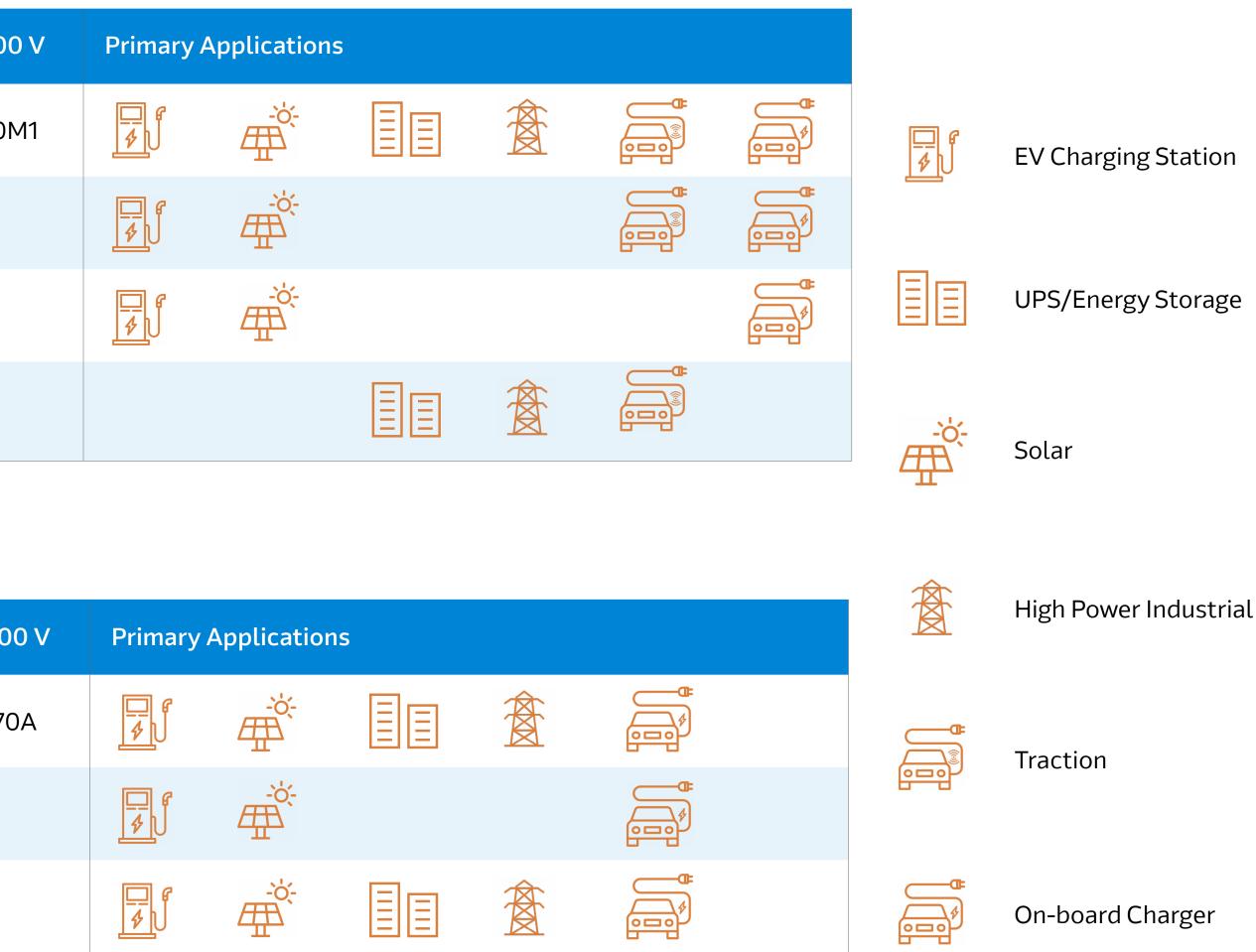
Family	Series	Optimization	650 V	900 V	1200 V	1700
M1	M1	Low R _{DS(on)} High SCWT			120SC1	170N
M2	M2	Low R _{DS(on)} High SCWT	065SC1	090SC1		
	M3S	High speed			120M3S	
МЗ	M3T	Low R _{DS(on)} High SCWT			120M3x SCWT dependent	

Diodes

D1 High IFSM065A120A	170
D2 Low QC065B	
D3 Low QC x VF120C	

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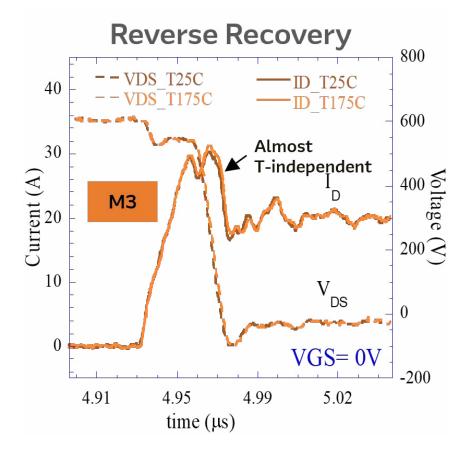
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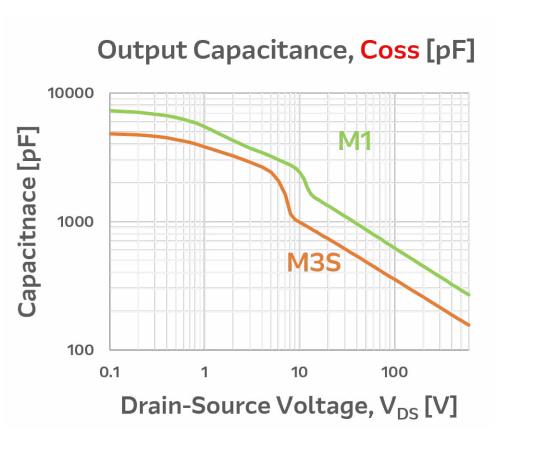


onsemi EliteSiC - Benefits of 3rd Generation SiC MOSFETs

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Key Parameters @ c	onditions, RT	M1 20mΩ, NTH4L020N120SC1 M3 22mΩ, NTH4L022N120M3	
V _{gs(op)} [V]		20V/-5V	18V/-3V
$R_{ds(on)}$ [m Ω]	@ Vgs=18V, 40A	21.9	21.6
Q _g [nC]	@ 800V, 40A, Vgs=18/-3V	191	135
E _{oss} [uJ]	@ 600V	63	36
FOM 1 [Ω *nC]	Rds(on) * Qg	4.2	2.9 31% ↓
FOM2 [Ω*uJ]	Rdson * Eoss	1.38	0.77 44% ↓
E _{on} [uJ] w/SiC-SBD	Inductive load switching	280	219
E _{on} [uJ] w/Body-D	@ 800V, 40A	769	415
E _{off} [uJ]	@ Rg=4.7Ω, Vgs=18V/-3V	420	251
V _{SD} [V]	@ 30A, Vgs=-3V	3.63	4.28
t _{rr} [ns]	$\bigcirc 100$ $21(0/max)/max 21()$	28	18
Q _{rr} [ns]	@ 40A, 2kA/us, Vgs=-3V	347	188



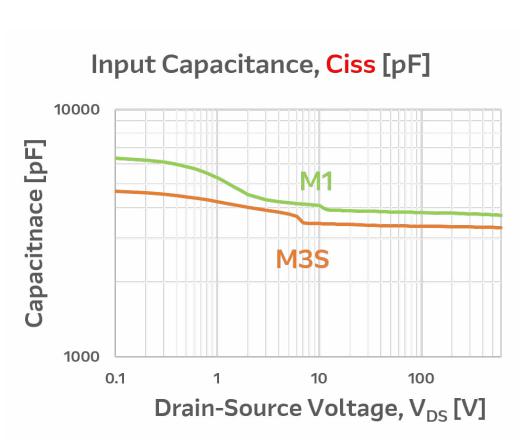


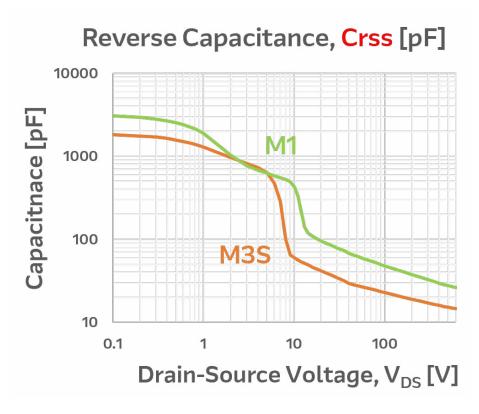
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3rd Generation SiC offering

- Optimized for high temperature operation
- Stable reverse recovery over temperature
- Improved parasitic
 capacitances for high
 frequency high efficiency
 application
- Large die with low R_{DS(on)}
 available







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1200V SiC MOSFETs – M3 Family

Automotive grade uses "NV" Industrial grade uses "NT"

R _{DS(ON)} (mΩ) Typical @Vgs: 18V	TO-247-3L	TO-247-4L	D2PAK-7L
	onsemi	onsemi	onsemi
14		NTH4L014N120M3P	NTBG014N120M3P
22	NTHL022N120M3S	NTH4L022N120M3S NVH4L022N120M3S	NTBG022N120M3S NVBG022N120M3S
29	NTHL030N120M3S	NTH4L030N120M3S NVH4L030N120M3S	NTBG030N120M3S NVBG030N120M3S
40	NTHL040N120M3S	NTH4L040N120M3S NVH4L040N120M3S	NTBG040N120M3S NVBG040N120M3S
65	NTHL070N120M3S	NTH4L070N120M3S NVH4L070N120M3S	NTBG070N120M3S NVBG070N120M3S

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Ideal Energy and Industrial Applications for SiC

Silicon Carbide (SiC) is ideal for use cases such as solar energy equipment, energy storage, alternative energy modes, and high voltage applications. SiC semiconductor's higher mechanical, chemical and thermal stability increases its efficiency and reduces cooling requirements for these and other industrial applications. Additionally, using SiC also simplifies design without sacrificing performance by reducing passive components.



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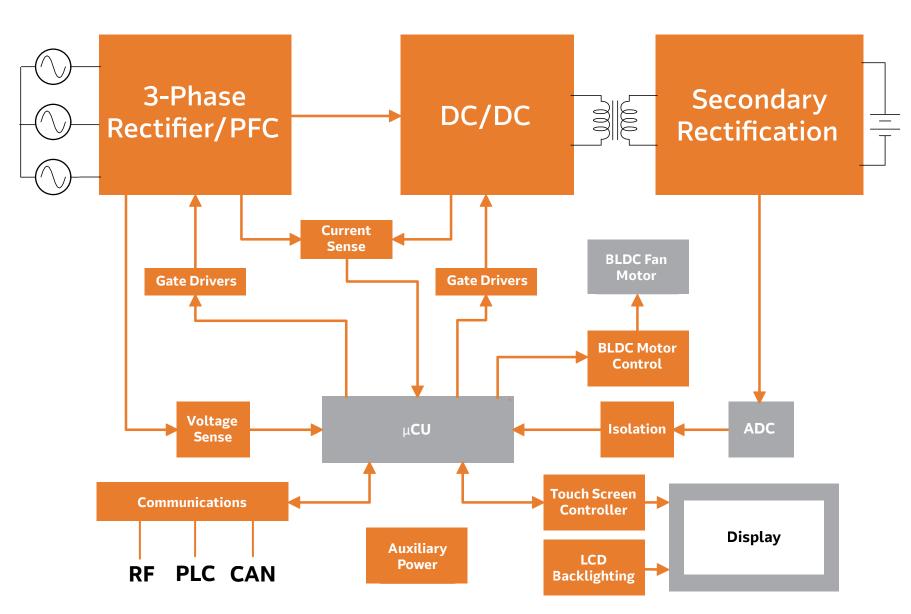
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EV Charging Stations

High-voltage SiC power devices enable the rapid-charging infrastructure that is the last major barrier to the widespread adoption of EV-based transportation. SiC is very efficient at high voltages, enabling fast battery charging times comparable to filling the tank of conventional vehicles.

onsemi's leading EliteSiC technology and innovative packaging solutions help simplify the design process for EV chargers. With a comprehensive portfolio of discrete power, analog solutions, protections, sensing, and connectivity, **onsemi** offers the industry's most comprehensive portfolio of high-quality components that can be tailored to specific needs.



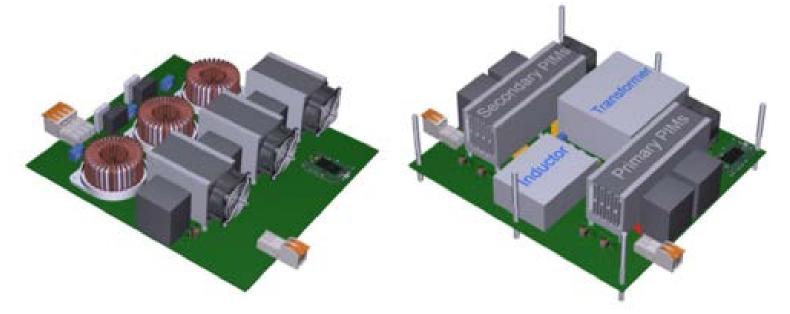
DC Fast Charger

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Reference Design

25 kW PFC Stage and DC-DC Stage for EV Charging Station Solution



300 kW EV Charging Station can be Built Using 12 x 25 kW Building Blocks

25 kW building block	25 kW building block
25 kW building block	25 kW building block
25 kW building block	25 kW building block
25 kW building block	25 kW building block
25 kW building block	25 kW building block
25 kW building block	25 kW building block

– Read Article Series: Developing A 25-kW SiC-Based Fast DC Charger Part 1 Part 2 Part 3

		<u>r ure 5</u>
Part 4	Part 5	Part 6

– Watch Webinars: 25 kW DC Fast Charging

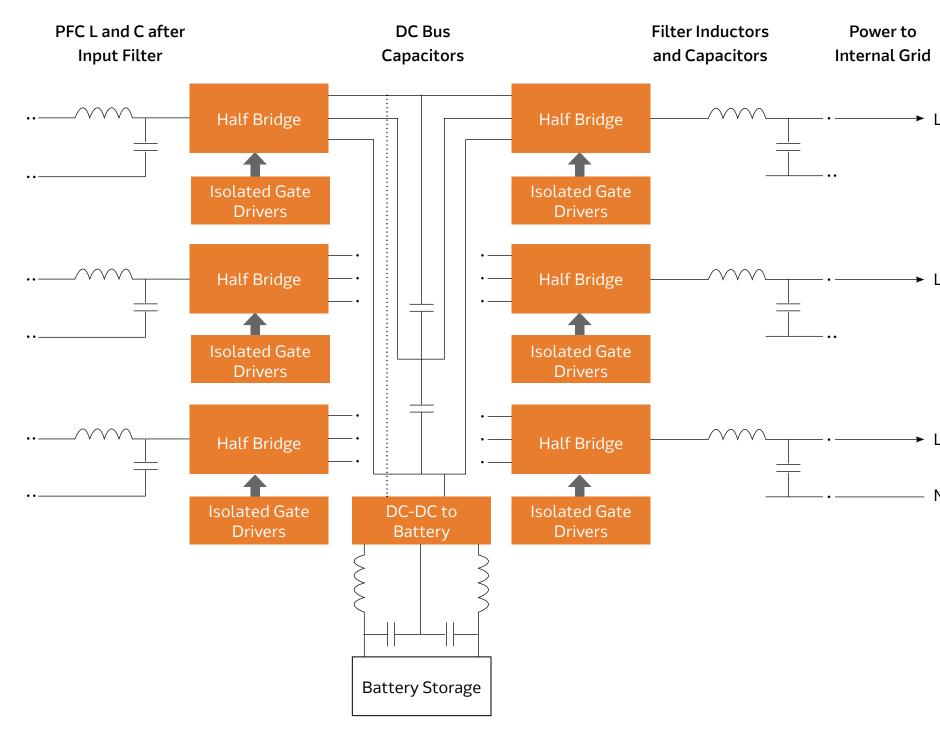
Session 2 Session 3 Session 4 Session 1

Battery

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Uninterruptible Power Supplies (UPS)

onsemi' Silicon Carbide (SiC) MOSFETs, diodes, and modules together with versatile Gate Drivers, power conversion, sensing, and protection IC families address requirements of high-power UPS designs. Combined with **onsemi**'s long-term expertise in power management and conversion, customers can deploy **onsemi** MOSFETs to develop UPS systems that maximize power quality and reliability.



UPS 3 Phase with a Full SiC Approach

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Demystifying Three-Phase PFC Topologies

Evaluation Boards

Three-phase On Board Charger (OBC) PFC-LLC Platform

The SEC-3PH-11-OBC-EVB is a modular platform that serves as a learning environment for three-phase AC/DC power conversion in an OBC application. It includes a performance 1200 V SiC MOSFET, 6A SiC MOSFET Gate Driver, and a SiC Diode 650 V.



Part number: SEC-3PH-11-OBC-EVB

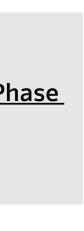
and technologies.

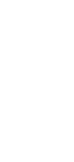
Gate Drivers Plug-and-Play Ecosystem

SECO-GDBB-EVB is the baseboard for the Gate Driver plug-and-play ecosystem, which allows for the comparison of the dynamic performance and capabilities of different Gate Drivers



Part number: SECO-GDBB-GEVB





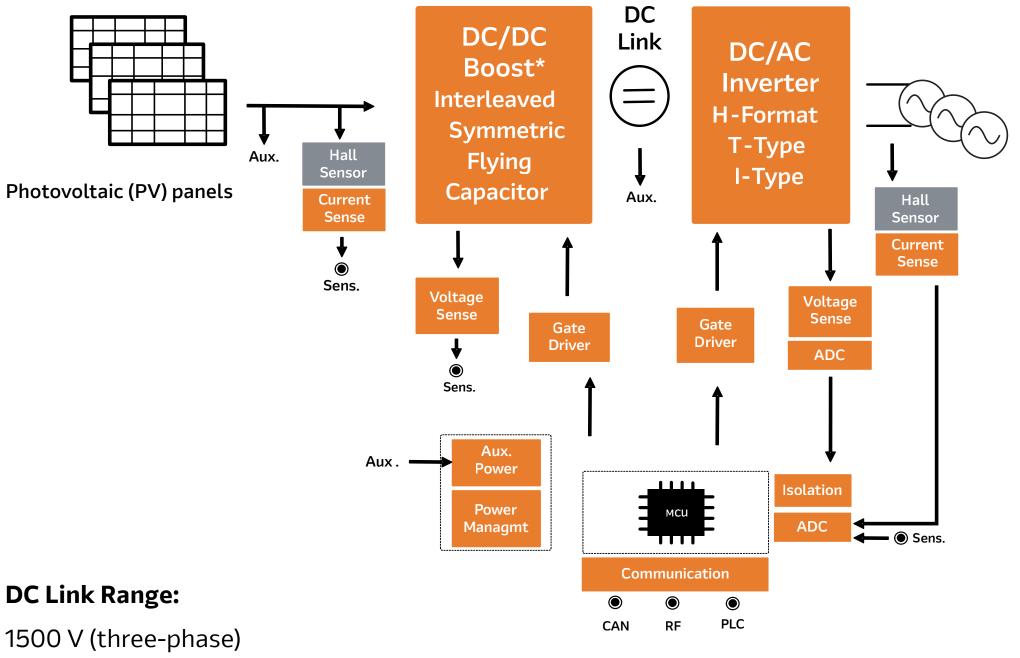




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Solar Inverters

Solar inverters need to deliver high efficiencies, very often above 98%, while also ensuring high reliability. This is even more critical in utility applications, where system downtime adversely affects ROI. System-level cost is also a key factor for consideration when choosing technology underpinnings for solar inverters.



DC Link Range:

1500 V (three-phase) 1100 V (three-phase) ~ 350 - < 600 V (single-phase)

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onsemi Solutions for Single and Three-phase Solar Inverters

Grid Tie	Power	DC Link	Power Integrated Modules (PIM)		Discrete	
			DC-DC Boost	DC/AC Inverter	DC-DC Boost	DC, Inve
	100 kw - >250 kw	1500 V	 3-ch Symmetric (Q2) 3-ch Flying Cap (Q2) 	I-NPC-type (Q2)		
			2-ch Boost (00 01)	I-NPC-type (Q2)		
3-Phase	30 kw - 100 kw	1100 V	 3-ch Boost (Q0, Q1) 2-ch Boost (Q0) 	 T-type (Q0) Split T-type (Q1, Q2) Split T-type (Q2) 	•	
	8 kw - 30 kw	1100 V		3-ch T-type (Q1)	• •	•
Single Phase				●H6.5 / Q1	• • •	• •
Single	8 kw -			 T-type (Q0) Split T-type (Q1, Q2) Split T-type (Q2) 3-ch T-type (Q1) 		

- SiC (including hybrid)
- **IGBT** Trench
- SJ MOSFET



Resource: Solar Power Needs Silicon Carbide



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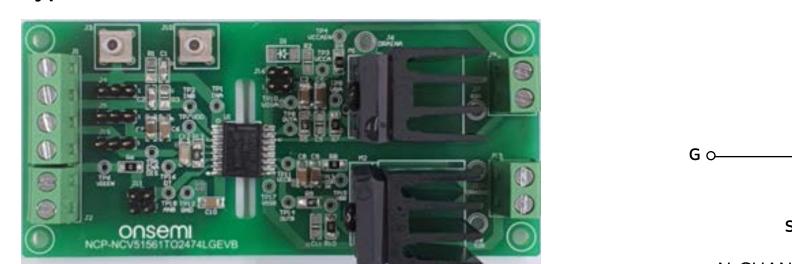
NCP51561 5KV Isolated SiC Gate Driver

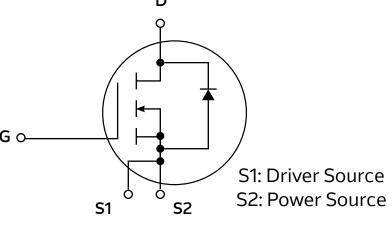
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Type A (3LD)



Type B (4LD)





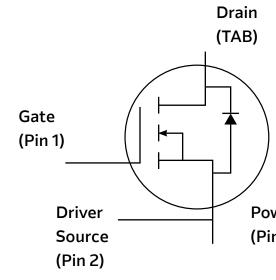
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N-CHANNEL MOSFET

N-CHANNEL MOSFET

Type C (7LD)





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N-CHANNEL MOSFET

NTHL020N120SC1			
1200V SiC (22mΩ)	Breakdown	SiC: TO-247-3LD	
onsem	Voltage:	R _{DS(on)} Range (25C)	
	1200 V	20m Ω to 160m Ω	
	900 V	$20m\Omega$ to $60m\Omega$	
	650 V	12m Ω to 57m Ω	

NTH4L022N120M3S 1200V SiC (22mΩ)	Breakdown Voltage:	SiC: TO-247-4LD
		R _{DS(on)} Range (25C)
	1200 V	$20m\Omega$ to $160m\Omega$
	900 V	20m Ω to 60m Ω
	750 V	13.5mΩ
TO-247-4L	650 V	$12m\Omega$ to $57m\Omega$

Breakdown Voltage:	SiC: TO-247-7LD	
	R _{DS(on)} Range (25C)	
1200 V	$20m\Omega$ to $160m\Omega$	
900 V	20m Ω to 60m Ω	
650 V	$12m\Omega$ to $43.5m\Omega$	

NTBG020N120SC1 1200V SiC (20mΩ)

TO-247-3L



D2PAK7L

Power Source (Pin 3, 4, 5, 6, 7)

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Getting Started Resources

Evaluation Boards

- Evaluation Board: <u>Three-phase</u> On Board Charger (OBC) PFC-LLC Platform (SEC-3PH-11-OBC-EVB)
- Evaluation Board: <u>6.6kW OBC SiC</u> model (SEC-6D6KW-OBC-SiC-GEVB)
- Evaluation Board: <u>A 6.6kW OBC</u> Evaluation Board using Totem Pole Topology (SEC-6D6KW-OBC-TTP-<u>GEVB)</u>

White Papers and Application Notes

- Electronic Devices
- **Drive Optimization**
- **Recommendations**
- <u>Q2, F1, F2)</u>

Reach out to your local Arrow sales or technical contacts for evaluation boards, samples, and design support.

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- White Paper: Physically Based, Scalable SPICE Modeling Methodologies for Modern Power

– White Paper: <u>SiC MOSFETs: Gate</u>

- Application Note: onsemi Gen 1 1200 V SiC MOSFETs & Modules: Characteristics and Driving

- Application Note: Mounting Instructions for PIM Modules (Q0, Q1,

Simulation Models

- SiC MOSFETs: Simulation Models for Silicon Carbide (SiC) MOSFETs
- SiC Diodes: <u>Simulation Models for</u> Silicon Carbide (SiC) Diodes



